

# SN54ABT16601, SN74ABT16601 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS210C – JUNE 1992 – REVISED JANUARY 1997

- **Members of the Texas Instruments Widebus™ Family**
- **State-of-the-Art EPIC-II<sup>™</sup> BiCMOS Design Significantly Reduces Power Dissipation**
- **UBT™ (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical V<sub>OLP</sub> (Output Ground Bounce) < 0.8 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

## description

These 18-bit universal bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, clocked, and clock-enabled modes.

Data flow in each direction is controlled by output-enable ( $\overline{\text{OEAB}}$  and  $\overline{\text{OEBA}}$ ), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable ( $\overline{\text{CLKENAB}}$  and  $\overline{\text{CLKENBA}}$ ) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. Output enable  $\overline{\text{OEAB}}$  is active low. When  $\overline{\text{OEAB}}$  is low, the outputs are active. When  $\overline{\text{OEAB}}$  is high, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B, but uses  $\overline{\text{OEBA}}$ , LEBA, CLKBA, and  $\overline{\text{CLKENBA}}$ .

To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16601 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16601 is characterized for operation from –40°C to 85°C.

SN54ABT16601 ... WD PACKAGE  
SN74ABT16601 ... DGG OR DL PACKAGE  
(TOP VIEW)

$\overline{\text{OEAB}}$	1	56	$\overline{\text{CLKENAB}}$
LEAB	2	55	CLKAB
A1	3	54	B1
GND	4	53	GND
A2	5	52	B2
A3	6	51	B3
V <sub>CC</sub>	7	50	V <sub>CC</sub>
A4	8	49	B4
A5	9	48	B5
A6	10	47	B6
GND	11	46	GND
A7	12	45	B7
A8	13	44	B8
A9	14	43	B9
A10	15	42	B10
A11	16	41	B11
A12	17	40	B12
GND	18	39	GND
A13	19	38	B13
A14	20	37	B14
A15	21	36	B15
V <sub>CC</sub>	22	35	V <sub>CC</sub>
A16	23	34	B16
A17	24	33	B17
GND	25	32	GND
A18	26	31	B18
$\overline{\text{OEBA}}$	27	30	CLKBA
LEBA	28	29	$\overline{\text{CLKENBA}}$

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus, EPIC-II, and UBT are trademarks of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 1997, Texas Instruments Incorporated

**SN54ABT16601, SN74ABT16601**  
**18-BIT UNIVERSAL BUS TRANSCEIVERS**  
**WITH 3-STATE OUTPUTS**

SCBS210C – JUNE 1992 – REVISED JANUARY 1997

FUNCTION TABLE†

INPUTS					OUTPUT B
CLKENAB	OEAB	LEAB	CLKAB	A	
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B <sub>0</sub> ‡
H	L	L	X	X	B <sub>0</sub> ‡
L	L	L	↑	L	L
L	L	L	↑	H	H
L	L	L	L	X	B <sub>0</sub> ‡
L	L	L	H	X	B <sub>0</sub> §

† A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, CLKBA, and CLKENBA.

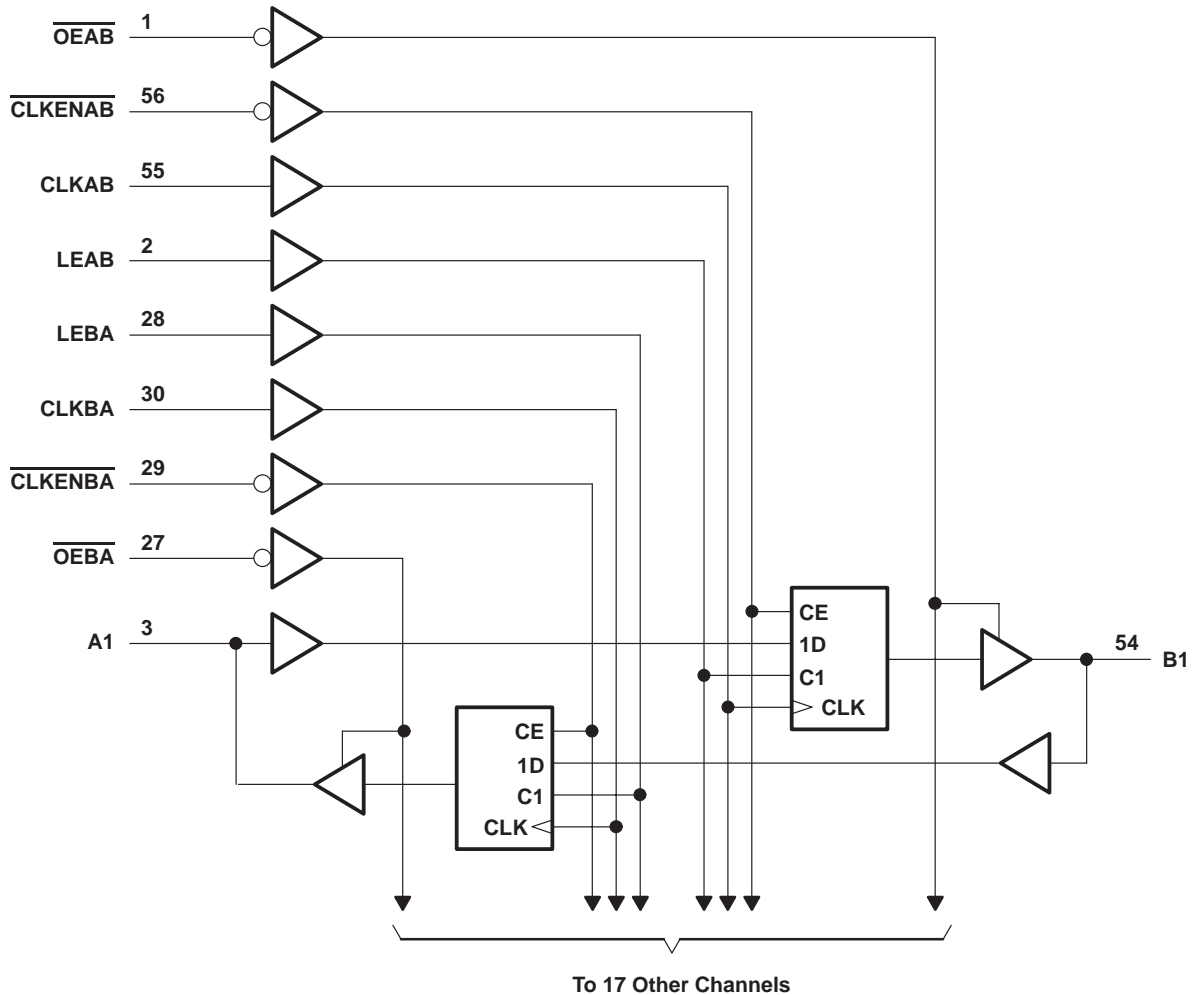
‡ Output level before the indicated steady-state input conditions were established

§ Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low

# SN54ABT16601, SN74ABT16601 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS210C – JUNE 1992 – REVISED JANUARY 1997

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16601	96 mA
SN74ABT16601	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

# SN54ABT16601, SN74ABT16601

## 18-BIT UNIVERSAL BUS TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS210C – JUNE 1992 – REVISED JANUARY 1997

#### recommended operating conditions (see Note 3)

			SN54ABT16601		SN74ABT16601		UNIT
			MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage		4.5	5.5	4.5	5.5	V
V <sub>IH</sub>	High-level input voltage		2		2		V
V <sub>IL</sub>	Low-level input voltage			0.8		0.8	V
V <sub>I</sub>	Input voltage		0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current			–24		–32	mA
I <sub>OL</sub>	Low-level output current			48		64	mA
Δt/Δv	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
T <sub>A</sub>	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T <sub>A</sub> = 25°C			SN54ABT16601		SN74ABT16601		UNIT	
				MIN	TYP†	MAX	MIN	MAX	MIN	MAX		
V <sub>IK</sub>		V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = –18 mA		–1.2			–1.2		–1.2		V	
V <sub>OH</sub>		V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = –3 mA		2.5			2.5		2.5		V	
		V <sub>CC</sub> = 5 V, I <sub>OH</sub> = –3 mA		3			3		3			
		V <sub>CC</sub> = 4.5 V		I <sub>OH</sub> = –24 mA			2					
				I <sub>OH</sub> = –32 mA			2*			2		
V <sub>OL</sub>		V <sub>CC</sub> = 4.5 V		I <sub>OL</sub> = 48 mA			0.55				V	
				I <sub>OL</sub> = 64 mA			0.55*		0.55			
V <sub>hys</sub>				100							mV	
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±1			±1		±1		μA	
	A or B ports			±20**			±100		±20			
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V		±100					±100		μA	
I <sub>CEX</sub>		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high	50			50		50		μA	
I <sub>O</sub> †		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V		–50	–100	–180	–50	–180	–50	–180	mA	
I <sub>OZH</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.7 V		10			10		10		μA	
I <sub>OZL</sub> §		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0.5 V		–10			–10		–10		μA	
I <sub>CC</sub>	A or B ports	V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND		Outputs high		1.9	3	2		3		mA
				Outputs low		28	36	35		36		
				Outputs disabled		1.6	3	2		3		
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND		50					50		μA	
							1.5				mA	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V		3							pF	
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V		9							pF	

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

\*\* This limit applies only to the SN74ABT16601.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

**SN54ABT16601, SN74ABT16601**  
**18-BIT UNIVERSAL BUS TRANSCEIVERS**  
**WITH 3-STATE OUTPUTS**

SCBS210C – JUNE 1992 – REVISED JANUARY 1997

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

			SN54ABT16601		SN74ABT16601		UNIT
			MIN	MAX	MIN	MAX	
$f_{\text{clock}}$	Clock frequency		0	150	0	150	MHz
$t_w$	Pulse duration	LEAB or LEBA high	2.5		2.5		ns
		CLKAB or CLKBA high or low	3		3		
$t_{\text{su}}$	Setup time	A before CLKAB $\uparrow$ or B before CLKBA $\uparrow$		4.6	4		ns
		A before LEAB $\downarrow$ or B before LEBA $\downarrow$	CLK high	2.5	2.5		
			CLK low	1.3	1		
		CLKEN before CLK $\uparrow$		2.9	2.5		
$t_h$	Hold time	A after CLKAB $\uparrow$ or B after CLKBA $\uparrow$		0.4	0		ns
		A after LEAB $\downarrow$ or B after LEBA $\downarrow$		2.8	2		
		CLKEN after CLK $\uparrow$		0	0		

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT16601				UNIT	
			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MIN		MAX
			MIN	TYP	MAX			
f <sub>max</sub>			150	200		150	MHz	
t <sub>PLH</sub>	A or B	B or A	1.5	2.5	4.1	1	4.6	ns
t <sub>PHL</sub>			1.5	3.4	4.7	1	5.1	
t <sub>PLH</sub>	LEAB or LEBA	B or A	2	3.4	4.7	1	5.6	ns
t <sub>PHL</sub>			2	3.7	5	1	5.5	
t <sub>PLH</sub>	CLKAB or CLKBA	B or A	1.5	3.2	4.5	1	5.2	ns
t <sub>PHL</sub>			1.5	3.2	4.4	1	5	
t <sub>PZH</sub>	OEAB or OEBA	B or A	2	4	5	1	5.7	ns
t <sub>PZL</sub>			2	4.2	5.6	1	6	
t <sub>PHZ</sub>	OEAB or OEBA	B or A	2	4.5	5.8	1	6.8	ns
t <sub>PLZ</sub>			1.5	3.4	5.3	1	6.3	

SN54ABT16601, SN74ABT16601  
 18-BIT UNIVERSAL BUS TRANSCEIVERS  
 WITH 3-STATE OUTPUTS

SCBS210C – JUNE 1992 – REVISED JANUARY 1997

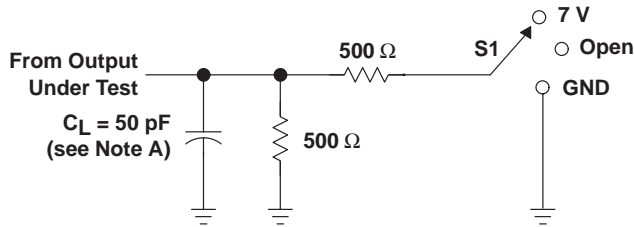
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT16601					UNIT
			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MIN	MAX	
			MIN	TYP	MAX			
f <sub>max</sub>			150	200		150		MHz
t <sub>PLH</sub>	A or B	B or A	1.5	2.5	3.6	1.5	4	ns
t <sub>PHL</sub>			1.5	3.4	4.7	1.5	4.9	
t <sub>PLH</sub>	LEAB or LEBA	B or A	2	3.4	4.7	2	5	ns
t <sub>PHL</sub>			2	3.7	5	2	5.2	
t <sub>PLH</sub>	CLKAB or CLKBA	B or A	1.5	3.2	4.5	1.5	4.7	ns
t <sub>PHL</sub>			1.5	3.2	4.4	1.5	4.6	
t <sub>PZH</sub>	$\overline{\text{OEAB}}$ or $\overline{\text{OEBA}}$	B or A	2	4	5	2	5.5	ns
t <sub>PZL</sub>			2	4.2	5.6	2	5.8	
t <sub>PHZ</sub>	$\overline{\text{OEAB}}$ or $\overline{\text{OEBA}}$	B or A	2	4.5	5.4	2	6.2	ns
t <sub>PLZ</sub>			1.5	3.4	4.7	1.5	5.4	

# SN54ABT16601, SN74ABT16601 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

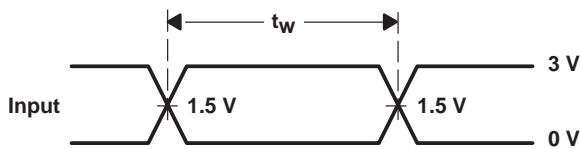
SCBS210C – JUNE 1992 – REVISED JANUARY 1997

## PARAMETER MEASUREMENT INFORMATION

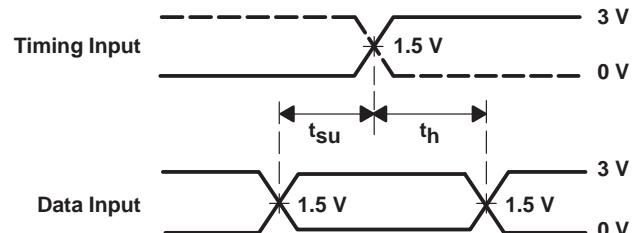


LOAD CIRCUIT

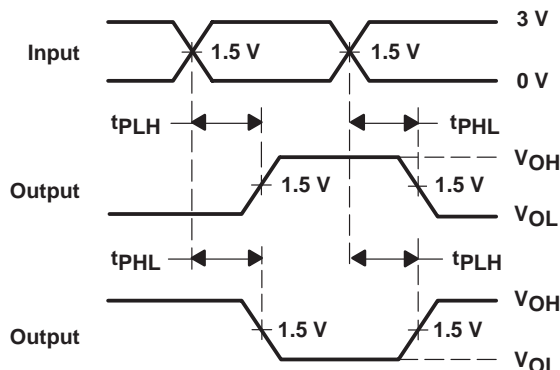
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



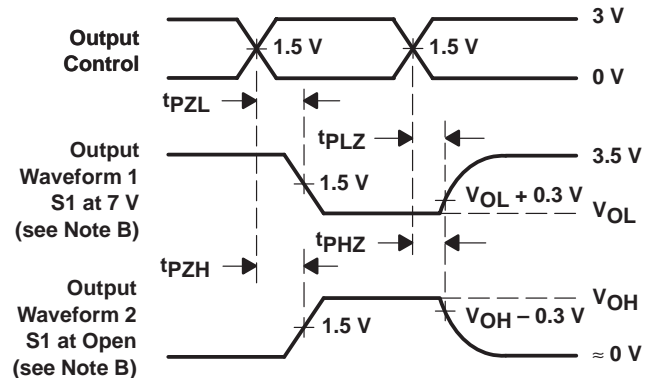
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

## **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.